

## IEC QUALITY ASSESSMENT SYSTEM (IECQ)

covering Electronic Components, Assemblies, Related Materials and Processes

For rules and details of the IECQ visit www.iecq.org

# Schedule of Scope to Certificate of Conformity

## **Hazardous Substance Process Management**

IECQ Certificate No.: IECQ-H TUVSUDSG 09.0001

CB Certificate No.: QC-2009-0002

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Issue to: SYSTEMS ON SILICON MANUFACTURING CO. PTE LTD

70 Pasir Ris Industrial Drive 1

Singapore 519527

### **Process or service in respect of which the company is Certified:**

Manufacture of Semiconductor Wafers

#### Process Detail(s)/Location(s):

The organisation subscribes to a list of 15 Banned Substances of the 'Joint Industry Guide (JIG), "Material Composition Declaration for Electronic Products". JIG - 101, April 2005 (Annex A)' as follow:

- 1. Cadmium and its compounds;
- 2. Chromium (VI) and its compounds;
- 3. Lead and its compounds (Exclude raw materials used in non lead-free packaging process;
- 4. Mercury and its compounds;
- 5. Polybrominated Biphenyls (PBB's) and their Ethers/Oxides (PBDE's);
- 6. Asbestos and its compounds;
- 7. Azo-Based Materials;
- 8. Certain Ethylene Glycol Ethers;
- 9. Ozone Depleting Substances;
- 10. Polychlorinated Biphenyls (PCB's);
- 11. Polychlorinated Napthalenes (more than 3 chlorine atoms);
- 12. Radioactive Substances;
- 13. Shortchain Chlorinated Paraffins;
- 14. Tributyl Tin, Triphenyl Tin and Oxides:
- 15. Tributyl Tin Oxide (TBTO)

